



Product Change Notification

#111434 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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Product Change Notification

Change Notification #: 111434 - 00
Change Title: Intel® Thermal Solution BXRTS2011LC,
PCN #111434-00, Product Material
Date of Publication: April 11, 2012

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

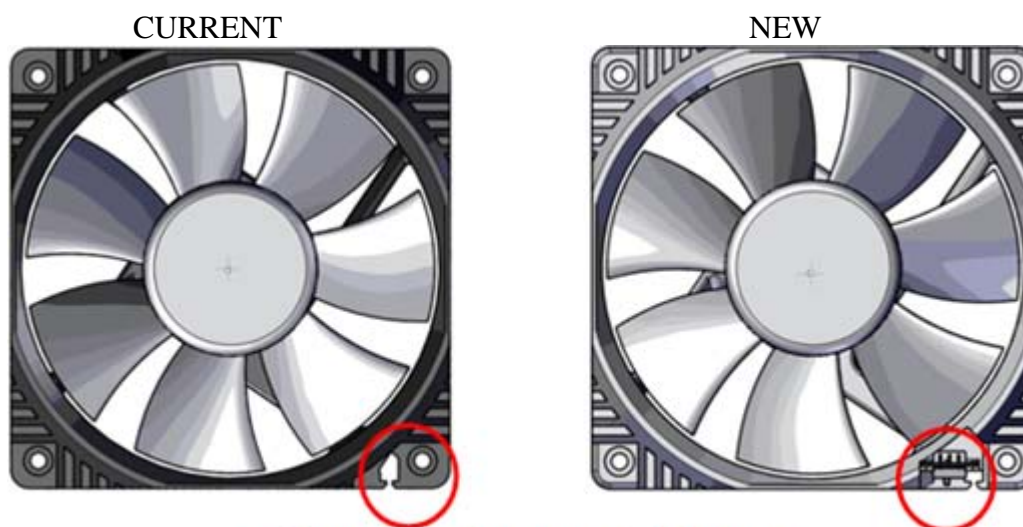
Date Customer Must be Ready to Receive Post-Conversion Material:	May 11, 2012
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Description of Change to the Customer:

In an effort to meet customer desired features and to help simplify the overall usability of the RTS2011LC liquid cooling solution Intel is making two major modifications to the current design. These design changes do not affect the performance of the thermal solution in any way. The changes are to address the look and feel and the installation of the solution.

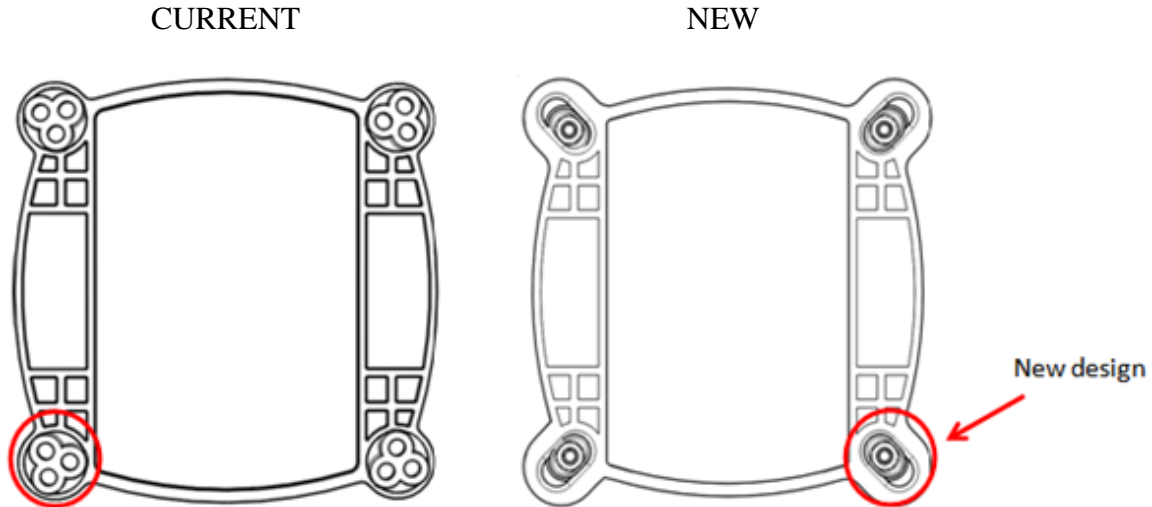
The changes will be as follows:

LED On/Off Switch



Addition of a switch to turn off the fan LEDs

Improved Bracket Design



The bracket re-design will use a sliding mechanism to line up the back plate captures instead of the installer selecting a specific mounting hole in the bracket.

Customer Impact of Change and Recommended Action:

There should be no impact to the customer with these changes. Intel feels that these changes will meet both the features set changes that customers have requested and will allow for easier installation of the thermal solution.

Note that you could see a mixture of new and old product until current inventory is depleted.

Products Affected / Intel Ordering Codes:

Marketing Name	Processor#	Pre Conversion Product Code	Pre Conversion MM#
Intel® Thermal Solution	BXRTS2011LC	BXRTS2011LC 918092	918092

PCN Revision History:

Date of Revision:

April 11, 2012

Revision Number:

00

Reason:

Originally Published PCN